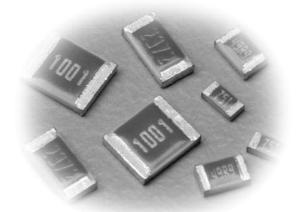




ultra precision 0.05%, 0.1%, 1% tolerance thin film chip resistor



features



- Nickel chromium thin film resistor element
- Marking: 1E: Black body with no marking 1J, 2A, 2B, 2E: green body with distinctive color marking

Dimensions inches (mm)

C

.008±.004

 (0.2 ± 0.1)

.012±.004

 (0.3 ± 0.1)

.016 + .008

 (0.4 ± 0.2)

.02±.012

 (0.5 ± 0.3)

d

.01 +.002 -.004

(0.25 ^{+0.05}_{-0.1})

.012±.004

 (0.3 ± 0.1) .012 ^{+.008} _{-.004}

 $(0.3^{+0.2}_{-0.1})$

.016 ^{+.008} _{-.004}

 $(0.4^{+0.2}_{-0.1})$

.014±.002

 (0.35 ± 0.05)

.018±.004

 (0.45 ± 0.1)

.02±.004

 (0.5 ± 0.1)

.024±.004

 (0.6 ± 0.1)

W

.02±.002

 (0.5 ± 0.05)

.031±.004

 (0.8 ± 0.1)

.049±.008

 (1.25 ± 0.2)

.063±.008

 (1.6 ± 0.2)

.098±.008

 (2.5 ± 0.2)

 Products with lead-free terminations meet EU RoHS requirements

.039 +.004

 $(1.0 \, {}^{+0.1}_{-0.05})$

.063±.008

 (1.6 ± 0.2)

.079±.008

 (2.0 ± 0.2)

.126±.008

 (3.2 ± 0.2)

Type

(Inch Size Code)

RN73 1E

(0402)

RN73 1J

(0603)

RN732A

(0805)

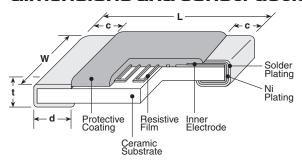
RN73 2B

(1206)

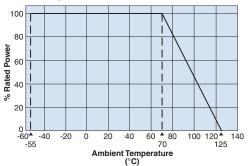
RN73 2E

(1210)

dimensions and construction



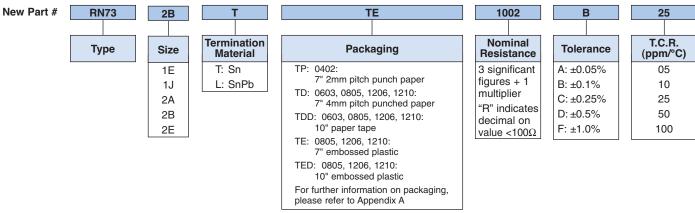
Derating (Curve
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power rating shall be derated in accordance with the above derating curve.

For resistors operated at an ambient temperature of 70°C or above, a

ordering information



Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.





ultra precision 0.05%, 0.1%, 1% tolerance thin film chip resistor

applications and ratings

Part Designation	Power Rating	T.C.R. (ppm/°C)	Resistance Range E-24, E-96, E-192*				Absolute Maximum Working	Absolute Maximum Overload	Operating Temp.	
	@ 70°C	Max.	(A±0.05%)	(B±0.1%)	(C±0.25%)	(D±0.5%)	(F±1.0%)	Voltage	Voltage	Range
RN731E	1/16W (.063W)	±25	_	100 Ω - 100k Ω	100Ω - 100kΩ	10Ω - 120kΩ	10Ω - 120kΩ	25V	50V	-55°C to +125°C
		±50	_	100 Ω - 100k Ω	100Ω - 100kΩ	10Ω - 120kΩ	10Ω - 120kΩ		30 V	
RN731J	1/16W (.063W)	±5	1KΩ - 47kΩ	100Ω - 47kΩ	_	_	_	50V	100V	
		±10	1KΩ - 47kΩ	100 Ω - 47k Ω	100Ω - 47kΩ	100 Ω - 47k Ω	100Ω - 47 kΩ			
		±25	1KΩ - 47kΩ	15Ω - 360kΩ	15Ω - 360kΩ	10Ω - 360kΩ	10Ω - 360kΩ			
		±50	_	15 Ω - 360k Ω	15Ω - 360kΩ	10Ω - 360 k Ω	10Ω - 360kΩ			
		±100	_	-	_	10 Ω - 360k Ω	10Ω - 360kΩ			
RN732A	1/10W (.10W)	±5	100Ω - 100kΩ	100 Ω - 100k Ω	_		_	100V	200V	
		±10	100Ω - 100kΩ	100 Ω - 100k Ω	100Ω - 100kΩ	100 Ω - 100k Ω	100Ω - 100kΩ			
		±25	51Ω - 100kΩ	15Ω - 1ΜΩ	15Ω - 1ΜΩ	10Ω - 1ΜΩ	10Ω - 1ΜΩ			
		±50	_	15 Ω - 1M Ω	15Ω - 1ΜΩ	10Ω - 1ΜΩ	10Ω - 1ΜΩ			
		±100	_	1	_	10 Ω - 1M Ω	10Ω - 1ΜΩ			
RN732B	1/8W (.125W)	±5	100Ω - 300kΩ	100 Ω - 300k Ω	_		_		50V 300V	
		±10	100Ω - 300kΩ	100 Ω - 300k Ω	100Ω - 300kΩ	100 Ω - 300k Ω	100Ω - 300kΩ			
		±25	51Ω - 300kΩ	15 Ω - 1M Ω	15Ω - 1ΜΩ	10 Ω - 1M Ω	10Ω - 1ΜΩ	150V		
		±50	_	15 Ω - 1M Ω	15Ω - 1ΜΩ	10Ω - $1M\Omega$	10Ω - 1ΜΩ			
		±100	_		_	10Ω - 1MΩ	10Ω - 1ΜΩ			
RN732E	1/4W (.25W)	±10	100Ω - 510kΩ	100 Ω - 510k Ω	100Ω - 510kΩ	100 Ω - 510k Ω	100Ω - 510kΩ	200V	400V	
		±25	51Ω - 510kΩ	15 Ω - 1M Ω	15Ω - 1ΜΩ	10Ω - 1ΜΩ	10Ω - 1ΜΩ			
		±50	_	15Ω - 1ΜΩ	15Ω - 1ΜΩ	10Ω - 1ΜΩ	10Ω - 1ΜΩ			
		±100	_	_	_	10 Ω - 1M Ω	10Ω - 1ΜΩ			

^{*} No marking on E-192 values

environmental applications

Performance Characteristics

	Requirement Δ R ±(%+0.05Ω)		
Parameter	Limit	Typical	Test Method
Resistance	Within specified tolerance	_	25°C
T.C.R.	Within specified T.C.R.	_	+25°C/+125°C: T.C.R. = ±5 (X10°/K) +25°C/-55°C and +25°C/+125°C: all others
Overload (Short time)	±0.1%	±0.01%	Rated Voltage x 2.5 or Max. overload voltage, whichever is less for 5 seconds
Resistance to Solder Heat	±0.1%	±0.04%	260°C ± 5°C, 10 seconds ± 1 second
Rapid Change of Temperature	±0.25%	±0.03%	-55°C (30 minutes), +125°C (30 minutes), 5 cycles
Moisture Resistance	±0.5%	±0.06%	40°C ± 2°C, 90%-95% RH, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle
Endurance at 70°C	±0.25%	±0.02%	70°C ± 2°C, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle
High Temperature Exposure	±0.25%	±0.03%	+125°C, 1000 hours

Precautions for Use

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure in the mounting and the parts are destructed by static electricity (1kV and more: 1J, 2A, 2B, 2E 0.5kV and more: 1E, Human Body Model 100pF 1.5kΩ) to change the resistance in the conditions of an excessive dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive static electricity when mounting on the boards.
- Ionic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na +), chlorine (Cl-) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RMA solder and flux are necessary since lead free solder contains ionic substances. Washing process is needed, before putting on moisture proof material in order to prevent electrical corrosion.
- Please pay attention that the top of an iron does not direct touch to the components. There is a risk that may cause a change in resistance. Take care that another
 risk may happen that the protecting coat is carbonized in an instant when touched directly by the top of the iron, also climatic-proof for electric corrosion or insulation
 of protecting coat may be dropped down. Be sure not to give high temperature on the top of the iron as it will degrade the protecting coat.
- Avoid storing components under direct sun rays, high temperature/humidity. Direct sun rays will cause quality change of taping and difficulty of keeping appropriate
 peeling strength. 5 ~35°C/35~75%RH, there is no deterioration of solderability for 12 months, but take special care for storing, because condensation, dust, and
 toxic gas like hydrogen sulfide, sulfurous acid gas, hydrogen chloride, etc. may drop solderability.
- The upper electrodes could be peeled off when a heat-resistant masking tape is attached to the mounted chip resistors and then detached from them. It is confirmed that the adhesiveness gets stronger due to the exposure to heat under mounting. Accordingly, we recommend the use of masking tape be refrained. If the use of heat-resistant masking tape is unavoidable, please make sure that the adhesives on the tape do not directly come in contact with the product.

For Surface Temperature Rise Graph see Environmental Applications. Additional environmental applications can also be found at www.koaspeer.com Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.